

DECLARATION  
and POWER OF ATTORNEY
☒ ORIGINAL  
☐ CONTINUATION  
☐ DIVISIONAL

As a below named inventor, I declare that the information given herein is true, that I believe that I am the original, first and sole inventor (if only one name is listed as 1 below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:  
**PROCESS FOR FORMING METAL PLATING FILM, PROCESS FOR MANUFACTURING ELECTRONIC COMPONENTS AND APPARATUS FOR FORMING PLATING FILM**  
 the specification of which is attached hereto unless the following box is checked:

☒ was filed on June 25, 2004, as United States Application Number or PCT International Application Number **PCT/JP2004/009353** and was amended on.

My residence, post office address and citizenship are as stated below next to my name.  
 I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations § 1.56(a).  
 I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  
 I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

## PRIOR FOREIGN APPLICATION(S)

COUNTRY	APPLICATION NUMBER	DATE OF FILING Month Day Year	PRIORITY CLAIMED UNDER 35 U.S.C. 119
Japan	2003-185894	June 27, 2003	Yes
Japan	2003-203377	July 29, 2003	Yes
Japan	2003-204151	July 30, 2003	Yes
Japan	2003-303758	August 27, 2003	Yes
Japan	2003-304798	August 28, 2003	Yes
Japan	2003-336276	September 26, 2003	Yes
Japan	2003-431560	December 25, 2003	Yes
Japan	2003-431562	December 25, 2003	Yes

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.) (Filing Date) (Status)

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorney(s) and/or Agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. ☒ Customer Number **000026021**

Send correspondence to: ☒ Customer Number **000026021** Hogan & Hartson L.L.P.  
 500 South Grand Avenue, Suite 1900  
 Los Angeles, California 90071  
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 213-337-8700

1	Name of Inventor <b>Nobuhiro HIGASHIHARA</b>	Residence: CITY <b>Osaka-shi, Osaka</b>	STATE or COUNTRY <b>Japan</b>
	Post Office Address <b>c/o KYOCERA CORPORATION, Osaka Tamatsukuri Office, 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka 540-8585, Japan</b>		<b>Japanese</b> CITIZENSHIP
2	Name of Inventor <b>Hideto SAKODA</b>	Residence: CITY <b>Osaka-shi, Osaka</b>	STATE or COUNTRY <b>Japan</b>
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3	Name of Inventor <b>Atsuyuki NAKAGAWA</b>	Residence: CITY <b>Osaka-shi, Osaka</b>	STATE or COUNTRY <b>Japan</b>
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4	Name of Inventor <b>Yoshiharu DAN</b>	Residence: CITY <b>Osaka-shi, Osaka</b>	STATE or COUNTRY <b>Japan</b>
	Post Office Address <b>c/o KYOCERA CORPORATION, Osaka Tamatsukuri Office, 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka 540-8585, Japan</b>		<b>Japanese</b> CITIZENSHIP

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 1 <i>Nobuhiro Higashihara</i>	SIGNATURE OF INVENTOR 2 <i>Hideto Sakoda</i>
DATE <i>December 9, 2005</i>	DATE <i>December 15, 2005</i>
SIGNATURE OF INVENTOR 3 <i>Atsuyuki NAKAGAWA</i>	SIGNATURE OF INVENTOR 4 <i>Yoshiharu Dan</i>
DATE <i>December 9, 2005</i>	DATE <i>December 12, 2005</i>

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☐ CONTINUATION  
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5074-1

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(Application Serial No.) (Filing Date) (Status)

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Send correspondence to:

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500 South Grand Avenue, Suite 1900  
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5	Name of Inventor	<b>Katsunori KITA</b>	Residence: CITY	<b>Osaka-shi, Osaka</b>	STATE or COUNTRY	<b>Japan</b>
	Post Office Address	<b>c/o KYOCERA CORPORATION, Osaka Tamatsukuri Office, 1-2-28, Tamatsukuri, Chuo-ku, Osaka-shi, Osaka 540-8585, Japan</b>			<b>Japanese</b>	CITIZENSHIP
6	Name of Inventor	<b>Kouichirou IKEUCHI</b>	Residence: CITY	<b>Osaka-shi, Osaka</b>	STATE or COUNTRY	<b>Japan</b>
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	Name of Inventor		Residence: CITY		STATE or COUNTRY	
	Post Office Address					CITIZENSHIP
	Name of Inventor		Residence: CITY		STATE or COUNTRY	
	Post Office Address					CITIZENSHIP

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

SIGNATURE OF INVENTOR 5	<i>Katsunori Kita</i>	SIGNATURE OF INVENTOR 6	<i>Kouichirou Ikeuchi</i>
DATE	<i>December 9, 2005</i>	DATE	<i>December 15, 2005</i>
SIGNATURE OF INVENTOR		SIGNATURE OF INVENTOR	
DATE		DATE	